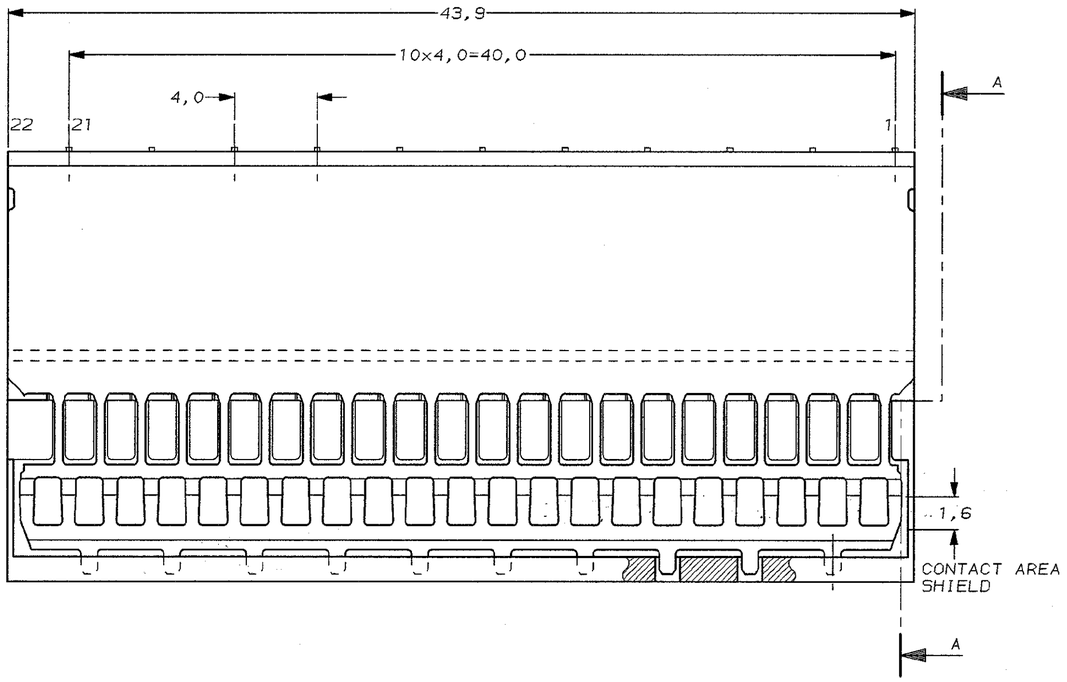
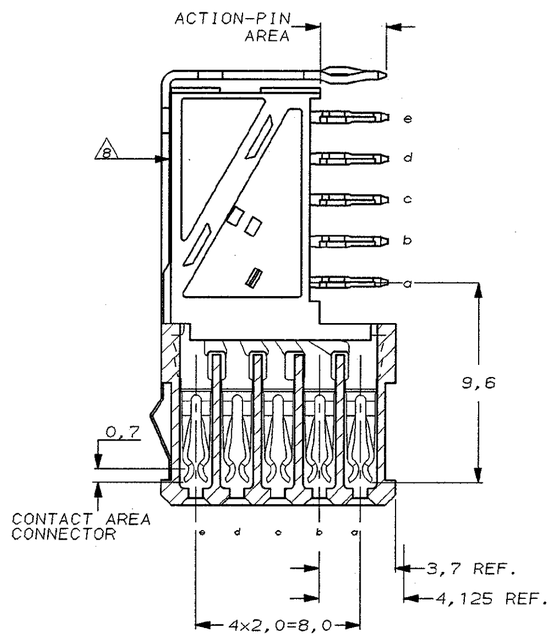
DO NOT SCALE | DIMENSIONS IN mm | METRIC | THIRD ANGLE PROJECTION

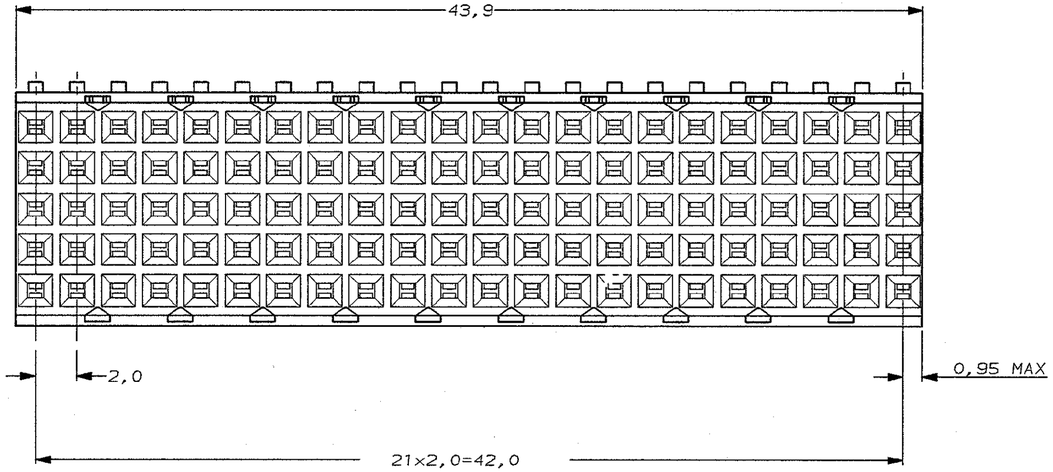


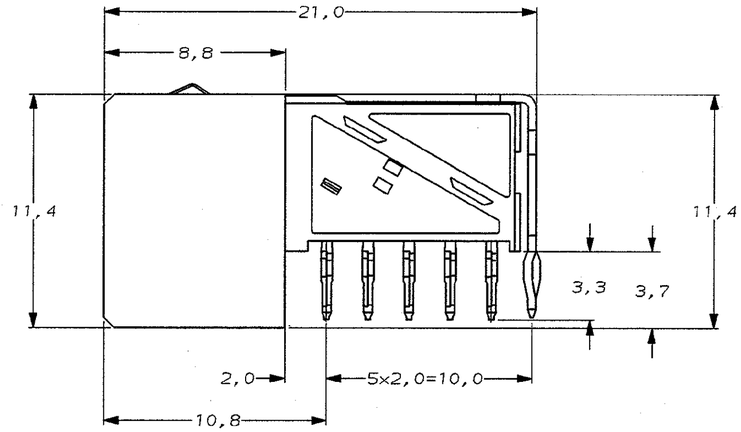
SECTION A-A



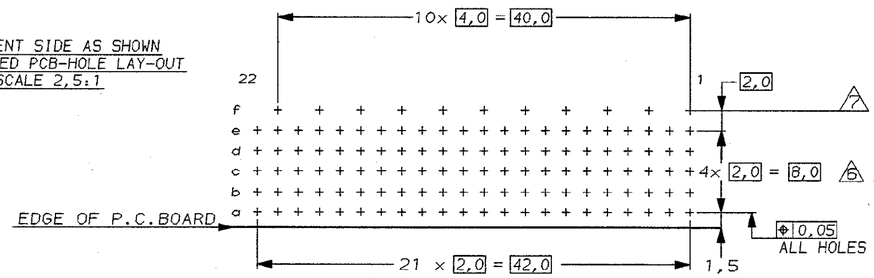
NOTES:

1. PLATING CONNECTOR:
   CONTACT AREA: 0,8µm Au MIN. OVER 1,3µm Ni MIN.
   ACTION PIN : 0,5µm SnPb MIN. OVER 1,3µm Ni MIN.
2. PLATING CONNECTOR:
   CONTACT AREA: 2,0µm Au MIN. OVER 1,3µm Ni MIN.
   ACTION PIN : 0,5µm SnPb MIN. OVER 1,3µm Ni MIN.
3. PLATING CONNECTOR:
   CONTACT AREA: 1,3µm Au MIN. OVER 1,3µm Ni MIN.
   ACTION PIN : 0,5µm SnPb MIN. OVER 1,3µm Ni MIN.
4. PLATING SHIELD:
   CONTACT AREA: 0,8µm Au MIN.
   ACTION PIN : 0,5µm SnPb MIN.
   REMAINDER : Ni FLASH
5. MATERIAL CONTACTS; PHOSPHORBRONZE
   MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
6. HOLE PATTERN FOR FEMALE CONNECTOR TYPE B
   110 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
7. ROW "f" 11 PLATED THROUGH HOLES FOR UPPERSHIELD
8. SHIELD MOUNTED ON CONNECTOR WITH DOUBLE SIDED ADHESIVE TAPE





COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT
SCALE 2,5:1



P.C.B. HOLE DIM. ACTION PIN	
DRILLED HOLE:	0,7±0,025mm
FIN. HOLE	: 0,55 TO 0,65mm
Cu-thks	: 0,025 TO 0,050mm
SnPb-thks	: 0,004 TO 0,010mm

THIS DRAWING IS PRELIMINARY

FINISH	MATERIAL	PARTNUMBER
3 4	5	352152-4
2 4	5	352152-3
1 4	5	352152-1

CUSTOMER DRAWING — FOR REFERENCE ONLY WILL NOT BE UPDATED

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THIS DRAWING IS UNPUBLISHED
~~RELEASED FOR PUBLICATION ,19~~

AMP — AMP-HOLLAND B.V. 's-Hertogenbosch, The Netherlands.

NAME: Z-PACK 2mm HM
110 POS. TYPE B (22 COLUMNS) WITH INTEGRATED GROUND RETURN UPPERSHIELD

LTR.	REVISION RECORD	DR.	CHK.	DATE
0	EH-1098-96	DT	WvdH	23-SEP-96

DR.:	CHK.:	APP.:	DWG.No.	REV.LTR.	SHEET	
D. TRUREN	W. V.D. HEIJDEN	B. MOOIJ	C-352152	0	1 OF 1	A2
DATE: 23-SEP-96	DATE: 23-SEP-96	DATE: .				

R6-129 (REV.04-91)

11 10 9 8 7 6 5 4 3 2 1

G F E D C B A